# **SiT9002**

## **LVPECL / HCSL / LVDS / CML** 1 to 220 MHz High Performance Spread Spectrum Oscillator

#### Features

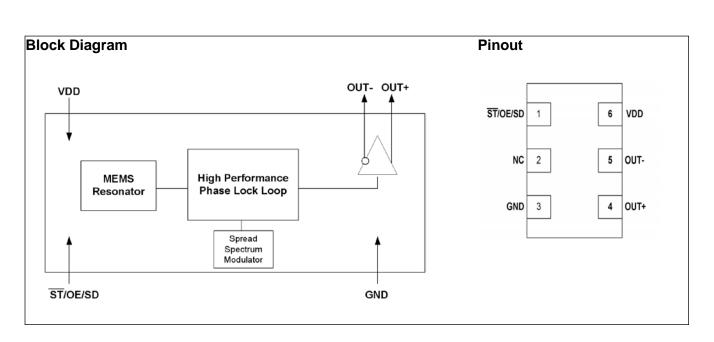
- · World's first differential spread spectrum oscillator
- Extremely low cycle-cycle jitter
  - As low as10 ps (typical)
- Wide frequency range
  - 1 MHz to 220 MHz
  - 220 MHz to 800 MHz (contact SiTime)
- Eight spread selections (31.5 KHz modulation rate)
  - Center Spread: ±0.25%, ±0.5%, ±1.0%, ±2.0%
  - Down Spread: -0.5%, -1.0%, -2.0%, -4.0%
  - For -0.25% and ±0.125% contact SiTime
- Low frequency stability (Spread = OFF)
  - ±25 ppm or ±50 ppm
- Operating voltage
  - $\bullet$  1.8V or 2.5 or 3.3 V
- Operating temperature range:
  - Industrial, -40°C to 85°C
  - Extended Commercial, -20°C to 70°C
- Small footprint
  - 5.0 x 3.2 x 0.75 mm
  - 7.0 x 5.0 x 0.90 mm
- Pb-free and RoHS compliant
- Ultra-reliable start up and greater immunity from interference

#### Benefits

- Services most PC peripherals, networking, and consumer applications
- Provides wide range of spread percentage for maximum electromagnetic interference (EMI) reduction
- Up to -17 dB reduction on third homonic and -12dB on the fundamental
- Fast time to market due to not needing to redesign the PCB for EMI reduction
- Factory programmable for ultra-fast lead time
- · No crystal or load capacitors required
- · Eliminates crystal qualification time
- 50%+ board saving space
- Completely quartz-free

#### Applications

- PCI-Express
- USB 3.0
- Fully Buffered DIMM
- Blade Server
- Router
- System Clock
- Networking and Computing
- Automotive
- Industrial



**SiT9002** 

## LVPECL / HCSL / LVDS / CML 1 to 220 MHz High Performance Spread Spectrum Oscillator



#### **Pin Description**

Pin No.	Name		Pin Description
1	ST/OE/SD	Input	Standby or Output Enable pin for OUT+ and OUT OE: When High or Open : OUT+ and OUT- = active When Low : OUT+ and OUT- = High Impedance state ST: When High or Open : OUT+ and OUT- = active When Low : OUT+ and OUT- = Output is low (weak pull down), oscillation stops SD: Spread Disable - disables spread spectrum When High or Open : Spread Spectrum modulation = active When Low : Spread Spectrum modulation = Off
2	NC	NA	No connect pin, leave it floating.
3	GND	Power	VDD power supply ground. Connect to ground
4	OUT+	Output	1 to 220 MHz programmable clock output. For frequencies > 220 MHz contact SiTime
5	OUT-	Output	
6	VDD	Power	Power supply

#### Absolute Maximum Ratings

Attempted operation outside the absolute maximum ratings of the part may cause permanent damage to the part. Actual performance of the IC is only guaranteed within the operational specifications, not absolute maximum ratings.

#### Absolute Maximum Table

Parameter	Min.	Max.	Unit
Storage Temperature	-65	150	°C
VDD	-0.5	4	V
Vin	GND - 0.5	VDD + 0.5	V
Theta JA (with copper plane on VDD and GND) 5.0 x 3.2 package	-	68	°C/W
7.0 x 5.0 package when center pad is soldered down 7.0 x 5.0 package when center pad is not soldered down	_	38	°C/W
7.0 x 5.0 package when center pad is not soldered down	e        65         150           -0.5         4           GND - 0.5         4           GND - 0.5         VDD +           ber plane on VDD and GND) 5.0 x 3.2 package         -         68           when center pad is soldered down         -         38           when center pad is not soldered down         -         38           ftraces of 0.010 inch to all pins) 5.0 x 3.2 package         -         45           when center pad is soldered down         -         35           when center pad is not soldered down         -         35           when center pad is not soldered down         -         45           when center pad is not soldered down         -         35           when center pad is not soldered down         -         15           writes         -         14           over (follow standard Pb free soldering guidelines)         -         16000           Writes         -         1         10000         -           over -40 to 125C, Process, VDD (0 to 3.6V)         -         1,0000         -           odel (JESD22-C101)         750         -         -	90	°C/W
Theta JC (with PCB traces of 0.010 inch to all pins) 5.0 x 3.2 package	-	45	°C/W
7.0 x 5.0 package when center pad is soldered down	_	35	°C/W
7.0 x 5.0 package when center pad is not soldered down	-65         150           -65         150           -0.5         4           GND - 0.5         VDD + 0.1           D and GND) 5.0 x 3.2 package         -           is soldered down         -           is not soldered down         -           inch to all pins) 5.0 x 3.2 package         -           is soldered down         -           is soldered down         -           is soldered down         -           is not soldered down         -           0         -           101         -	48	°C/W
Soldering Temperature (follow standard Pb free soldering guidelines)	-	260	°C
Number of Program Writes	_	1	NA
Program Retention over -40 to 125C, Process, VDD (0 to 3.6V)	-	1,000+	years
Human Body Model (JESD22-A114)	2000	_	V
Charged Device Model (JESD22-C101)	750	_	_
Machine Model (JESD22-A115)	200	_	_

#### **DC Electrical Specifications**

#### **Environmental Compliance**

Parameter	Condition/Test Method
Mechanical Shock	MIL-STD-883F, Method 2002
Mechanical Vibration	MIL-STD-883F, Method 2007
Temperature Cycle	MIL-STD-883F, Method 1010-65-150°C (1000 cycle)
Solderability	MIL-STD-883F, Method 2003
Moisture Sensitivity Level	MSL1 @ 260°C



# LVCMOS input, OE or $\overline{ST}$ pin, 3.3V ± 10% or 2.5V ± 10% or 1.8V ± 5%, -40 to 85°C

Symbol	Parameter	Condition	Min.	Тур.	Max.	Unit
V <sub>IH</sub>	Input High Voltage		70	-	-	%Vdd
V <sub>IL</sub>	Input Low Voltage		_	-	30	%Vdd
I <sub>IH</sub>	Input High Current	OE or ST or SD pin	-	_	10	uA
IIL	Input Low Current	OE or ST or SD pin	-10	-	-	uA
Т <sub>ри</sub>	Power Up Time	Time from minimum power supply voltage to the first cycle (Guaranteed no runt pulses)	_	_	10	ms

#### LVPECL, $3.3V \pm 10\%$ or $2.5V \pm 10\%$ , -40 to $85^{\circ}C$

Symbol	Parameter	Condition	Min.	Тур.	Max.	Unit
V <sub>DD</sub>	Supply Voltage		2.97	3.3	3.63	V
			2.25	2.5	2.75	V
I <sub>DD</sub>	Supply Current	$V_{DD}$ = 3.3, Excluding Load Termination Current	-	75	84	mA
		$V_{DD}$ = 2.5, Excluding Load Termination Current	-	75	84	mA
V <sub>OH</sub>	Output High Voltage	50 Ohm termination to V <sub>DD</sub> - 2.0V	V <sub>DD</sub> -1.1	_	V <sub>DD</sub> -0.7	V
V <sub>OL</sub>	Output Low Voltage	See Figure 2,3.	V <sub>DD</sub> -2.0	_	V <sub>DD</sub> -1.4	V
V <sub>swing</sub>	Pk-Pk Output Voltage Swing		600	800	1000	mV

#### HCSL, 3.3V $\pm$ 10% or 2.5V $\pm$ 10%, -40 to 85°C

Symbol	Parameter	Condition	Min.	Тур.	Max.	Unit
V <sub>DD</sub>	Supply Voltage		2.97	3.3	3.63	V
			2.25	2.5	2.75	V
I <sub>DD</sub>	Supply Current	$V_{DD}$ = 3.3, Excluding Load Termination Current	_	73	80	mA
		$V_{DD}$ = 2.5, Excluding Load Termination Current	_	73	80	mA
V <sub>OH</sub>	Output High Voltage	50 Ohm termination to GND	0.6	0.75	0.95	V
V <sub>OL</sub>	Output Low Voltage	See Figure 4.	0.0	-	50	mV
V <sub>swing</sub>	Pk-Pk Output Voltage Swing		600	750	950	mV

#### LVDS, $3.3V \pm 10\%$ or $2.5V \pm 10\%$ , -40 to $85^{\circ}C$

Symbol	Parameter	Condition	Min.	Тур.	Max.	Unit
V <sub>DD</sub>	Supply Voltage		2.97	3.3	3.63	V
			2.25	2.5	2.75	V
I <sub>DD</sub>	Supply Current	V <sub>DD</sub> = 3.3, Excluding Load Termination Current	-	75	85	mA
		V <sub>DD</sub> = 2.5, Excluding Load Termination Current	-	70	77	mA
V <sub>OD1</sub>	Differential Output Voltage	Swing Mode = Normal	250	350	450	mV
$\Delta V_{OD1}$	V <sub>OD</sub> Magnitude Change	Single load termination. See Figure 5.	-	_	50	mV
V <sub>OS1</sub>	Offset Voltage		-	1.2	-	V
$\Delta V_{OS1}$	V <sub>OS</sub> Magnitude Change		-	_	50	mV
V <sub>OD2</sub>	Differential Output Voltage	Swing Mode = High	500	700	900	mV
$\Delta V_{OD2}$	V <sub>OD</sub> Magnitude Change	Single load termination. See Figure 5.	-	_	50	mV
V <sub>OS2</sub>	Offset Voltage	Dee Figure 5.	-	1.2	_	V
$\Delta V_{OS2}$	V <sub>OS</sub> Magnitude Change		-	-	50	mV
V <sub>OD3</sub>	Differential Output Voltage	Swing Mode = High	250	350	450	mV
$\Delta V_{OD3}$	V <sub>OD</sub> Magnitude Change	Double load termination. See Figure 6.	-	_	50	mV
V <sub>OS3</sub>	Offset Voltage		-	1.2	-	V
$\Delta V_{OS3}$	V <sub>OS</sub> Magnitude Change		_	_	50	mV



### CML, 3.3V $\pm$ 10% or 2.5V $\pm$ 10% or 1.8V $\pm$ 5%, -40 to 85°C

Symbol	Parameter	Condition		Min.	Тур.	Max.	Unit
V <sub>DD</sub>	Supply Voltage			2.97	3.3	3.63	V
				2.25	2.5	2.75	V
				1.71	1.8	1.89	V
I <sub>DD</sub>	Supply Current	V <sub>DD</sub> = 3.3V	Excluding Load	-	48	51	mA
		$V_{DD} = 2.5V$	Termination Current	-	48	51	mA
		V <sub>DD</sub> = 1.8V		-	48	51	mA
V <sub>OH1</sub>	Output High Voltage	Swing Mode = Normal	·	V <sub>DD</sub> -0.1	-	V <sub>DD</sub>	V
V <sub>OL1</sub>	Output Low Voltage	Single Load Termination See Figure 7.		V <sub>DD</sub> -0.55	V <sub>DD</sub> -0.425	V <sub>DD</sub> -0.3	V
V <sub>swing1</sub>	Pk-Pk Output Voltage Swing			300	425	550	mV
V <sub>OH2</sub>	Output High Voltage	Swing Mode = High		V <sub>DD</sub> -0.1	-	V <sub>DD</sub>	V
V <sub>OL2</sub>	Output Low Voltage	Single Load Termination See Figure 7.		V <sub>DD</sub> -1.1	V <sub>DD</sub> -0.85	V <sub>DD</sub> -0.6	V
V <sub>swing2</sub>	Pk-Pk Output Voltage Swing			600	850	1100	mV
V <sub>OH3</sub>	Output High Voltage	Swing Mode = High		V <sub>DD</sub> -0.1	-	$V_{DD}$	V
V <sub>OL3</sub>	Output Low Voltage	Double Load Termination See Figure 8.		V <sub>DD</sub> -0.55	V <sub>DD</sub> -0.425	V <sub>DD</sub> -0.3	V
V <sub>swing3</sub>	Pk-Pk Output Voltage Swing			300	425	550	mV

# **AC Electrical Specifications**

LVPECL, 3.3V ± 10%, -40 to 85°C

Symbol	Parameter	Condition	Condition		Тур.	Max.	Unit
Fout	Output Frequency			1.0	-	220	MHz
F <sub>stab</sub>	Frequency Stability	Inclusive of initial stability,	-20 to 70°C	-25	-	+25	ppm
		operating temp., rated power supply voltage change, load change	-40 to 85°C	-50	-	+50	ppm
F <sub>age</sub>	Aging	First year @ 25°C	First year @ 25°C		-	1	PPM
DC	Duty Cycle			45	-	55	%
t <sub>R</sub> /t <sub>F</sub>	Output Rise/Fall Time	20% to 80%		100	150	300	ps
T <sub>CCJ</sub>	Cycle-Cycle Jitter	F <sub>out</sub> = 100 MHz, -0.5% down spre	ead	-	10	16	ps
		F <sub>out</sub> = 150 MHz, -0.5% down spread		—	8	14	ps
		F <sub>out</sub> = 200 MHz, -0.5% down spre	ead	-	8	14	ps

#### LVPECL, 2.5V ± 10%, -40 to 85°C

Symbol	Parameter	Condition	Condition		Тур.	Max.	Unit
Fout	Output Frequency				-	220	MHz
F <sub>stab</sub>	Frequency Stability	Inclusive of initial stability,	-20 to 70°C	-25	_	+25	ppm
		supply voltage change, load change	-40 to 85°C	-50	-	+50	ppm
F <sub>age</sub>	Aging	First year @ 25°C	First year @ 25°C		-	1	PPM
DC	Duty Cycle			45	_	55	%
t <sub>R</sub> /t <sub>F</sub>	Output Rise/Fall Time	20% to 80%		100	150	300	ps
T <sub>CCJ</sub>	Cycle-Cycle Jitter	F <sub>out</sub> = 100 MHz, -0.5% down spr	ead	_	10	16	ps
		F <sub>out</sub> = 150 MHz, -0.5% down spread           F <sub>out</sub> = 200 MHz, -0.5% down spread		_	8	14	ps
				-	8	14	ps



#### HCSL, 3.3V ± 10%, -40 to 85°C

Symbol	Parameter	Condition	Condition		Тур.	Max.	Unit
F <sub>out</sub>	Output Frequency				_	220	MHz
F <sub>stab</sub>	Frequency Stability	Inclusive of initial stability, operating temp., rated power	-20 to 70°C	-25	-	+25	ppm
	change	-40 to 85°C	-50	-	+50	ppm	
F <sub>age</sub>	Aging	First year @ 25°C		_	-	1	PPM
DC	Duty Cycle			45	-	55	%
t <sub>R</sub> /t <sub>F</sub>	Output Rise/Fall Time	20% to 80%		200	280	375	ps
T <sub>CCJ</sub>	Cycle-Cycle Jitter	F <sub>out</sub> = 100 MHz, -0.5% down s	oread	_	10	16	ps
		F <sub>out</sub> = 150 MHz, -0.5% down spread		-	10	15	ps
		F <sub>out</sub> = 200 MHz, -0.5% down s	oread	_	10	15	ps

#### HCSL, 2.5V ± 10%, -40 to 85°C

Symbol	Parameter	Condition	Condition		Тур.	Max.	Unit
Fout	Output Frequency				-	220	MHz
F <sub>stab</sub>	operating temp., rated power	-20 to 70°C	-25	-	+25	ppm	
		supply voltage change, load change	-40 to 85°C	-50	-	+50	ppm
F <sub>age</sub>	Aging	First year @ 25°C	•	_	-	1	PPM
DC	Duty Cycle			45	-	55	%
t <sub>R</sub> /t <sub>F</sub>	Output Rise/Fall Time	20% to 80%		200	300	400	ps
T <sub>CCJ</sub>	Cycle-Cycle Jitter	F <sub>out</sub> = 100 MHz, -0.5% down s	pread	-	9	19	ps
		F <sub>out</sub> = 150 MHz, -0.5% down spread		-	9	17	ps
		$F_{out}$ = 200 MHz, -0.5% down s	F <sub>out</sub> = 200 MHz, -0.5% down spread		9	15	ps

#### LVDS, 3.3V ± 10%, -40 to 85°C

Symbol	Parameter	Condition		Min.	Тур.	Max.	Unit
Fout	Output Frequency				_	220	MHz
F <sub>stab</sub>	Frequency Stability	Inclusive of initial stability, operating temp., rated power		-25	-	+25	ppm
		supply voltage change, load	-40 to 85°C	-50	-	+50	ppm
F <sub>age</sub>	Aging	First year @ 25°C		-	-	1	PPM
DC	Duty Cycle			45	-	55	%
t <sub>R</sub> /t <sub>F</sub>	Output Rise/Fall Time	20% to 80%		100	200	325	ps
T <sub>CCJ</sub>	Cycle-Cycle Jitter	$F_{out}$ = 100 MHz, -0.5% down spread $F_{out}$ = 150 MHz, -0.5% down spread		_	11	19	ps
				-	11	20	ps
		F <sub>out</sub> = 200 MHz, -0.5% down s	oread	_	11	21	ps

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#### LVDS, 2.5V ± 10%, -40 to 85°C

Symbol	Parameter	Condition		Min.	Тур.	Max.	Unit
F <sub>out</sub>	Output Frequency				_	220	MHz
F <sub>stab</sub>	Frequency Stability	Inclusive of initial stability, operating temp., rated power		-25	-	+25	ppm
		supply voltage change, load -40 to change	-40 to 85°C	-50	-	+50	ppm
F <sub>age</sub>	Aging	First year @ 25°C		_	_	1	PPM
DC	Duty Cycle				-	55	%
t <sub>R</sub> /t <sub>F</sub>	Output Rise/Fall Time	20% to 80%		100	260	325	ps
T <sub>CCJ</sub>	Cycle-Cycle Jitter	F <sub>out</sub> = 100 MHz, -0.5% down s	F <sub>out</sub> = 100 MHz, -0.5% down spread		14	26	ps
		F <sub>out</sub> = 150 MHz, -0.5% down spread		_	14	26	ps
		F <sub>out</sub> = 200 MHz, -0.5% down s	oread	_	14	27	ps

#### CML, 3.3V ± 10%, -40 to 85°C

Symbol	Parameter	Condition		Min.	Тур.	Max.	Unit
Fout	Output Frequency				-	220	MHz
F <sub>stab</sub>	Frequency Stability	Inclusive of initial stability, operating temp., rated power	-20 to 70°C	-25	-	+25	ppm
		supply voltage change, load -40 change	-40 to 85°C	-50	-	+50	ppm
F <sub>age</sub>	Aging	First year @ 25°C	First year @ 25°C		_	1	PPM
DC	Duty Cycle				_	55	%
t <sub>R</sub> /t <sub>F</sub>	Output Rise/Fall Time	20% to 80%	20% to 80%		220	300	ps
T <sub>CCJ</sub>	Cycle-Cycle Jitter	F <sub>out</sub> = 100 MHz, -0.5% down s	$F_{out} = 100 \text{ MHz}, -0.5\% \text{ down spread}$ $F_{out} = 150 \text{ MHz}, -0.5\% \text{ down spread}$ $F_{out} = 200 \text{ MHz}, -0.5\% \text{ down spread}$		11	20	ps
		$F_{out}$ = 150 MHz, -0.5% down s			11	18	ps
		$F_{out}$ = 200 MHz, -0.5% down s			10	19	ps

#### CML, $2.5V \pm 10\%$ , -40 to $85^{\circ}C$

Symbol	Parameter	Condition	Condition		Тур.	Max.	Unit
Fout	Output Frequency				-	220	MHz
F <sub>stab</sub>	Frequency Stability	Inclusive of initial stability, -20 to 70°C operating temp., rated power		-25	-	+25	ppm
		supply voltage change, load -4	-40 to 85°C	-50	-	+50	ppm
F <sub>age</sub>	Aging	First year @ 25°C	First year @ 25°C		-	1	PPM
DC	Duty Cycle				-	55	%
t <sub>R</sub> /t <sub>F</sub>	Output Rise/Fall Time	20% to 80%	20% to 80%		230	300	ps
T <sub>CCJ</sub>	Cycle-Cycle Jitter	F <sub>out</sub> = 100 MHz, -0.5% down s	F <sub>out</sub> = 100 MHz, -0.5% down spread		13	22	ps
		F <sub>out</sub> = 150 MHz, -0.5% down spread		-	12	19	ps
		$F_{out}$ = 200 MHz, -0.5% down s	pread	_	11	20	ps

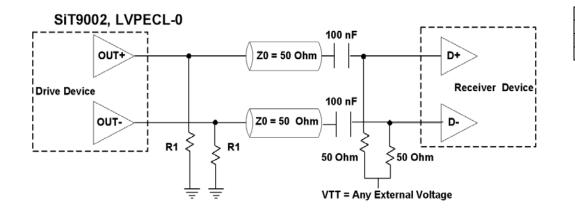
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#### CML, 1.8V $\pm$ 5%, -40 to 85°C

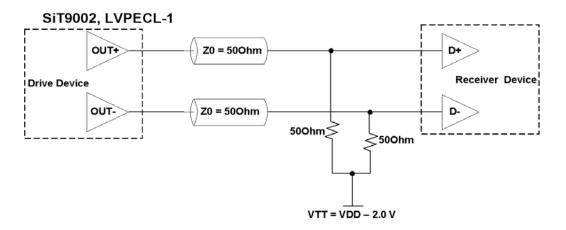
Symbol	Parameter	Condition		Min.	Тур.	Max.	Unit
F <sub>out</sub>	Output Frequency				-	220	MHz
F <sub>stab</sub>	Frequency Stability	Inclusive of initial stability, operating temp., rated power	operating temp., rated power		-	+25	ppm
		supply voltage change, load	-40 to 85°C	-50	_	+50	ppm
F <sub>age</sub>	Aging	First year @ 25°C	First year @ 25°C		_	1	PPM
DC	Duty Cycle				_	55	%
t <sub>R</sub> /t <sub>F</sub>	Output Rise/Fall Time	20% to 80%	20% to 80%		230	300	ps
T <sub>CCJ</sub>	Cycle-Cycle Jitter	F <sub>out</sub> = 100 MHz, -0.5% down s	F <sub>out</sub> = 100 MHz, -0.5% down spread		13	23	ps
		F <sub>out</sub> = 150 MHz, -0.5% down spread		-	12	22	ps
		$F_{out}$ = 200 MHz, -0.5% down s	pread	-	12	21	ps

#### **Termination Diagrams**



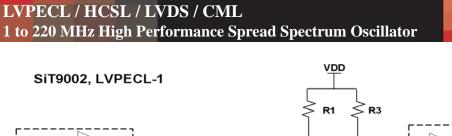
VDD = 3.3V
R1 = 150 Ohm
VDD = 2.5V
R1 = 120 Ohm

Figure 1. LVPECL AC Coupled Typical Termination



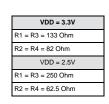


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Z0 = 500hm

Z0 = 500hm



D+

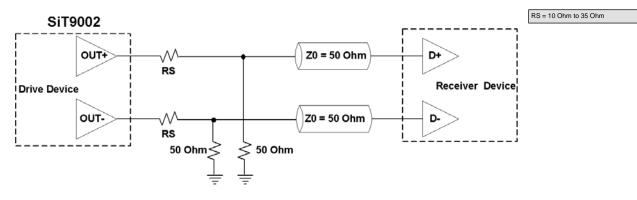
D-

**≤** R4

**Receiver Device** 

It's About Time

Figure 3. LVPECL DC Coupled Typical Termination without Termination Voltage



≤R2

Figure 4. HCSL Typical Termination

Note:

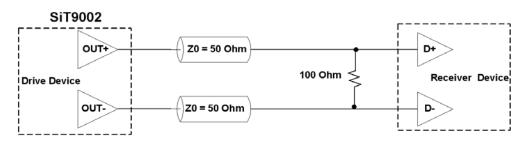
SiT9002

Drive Device

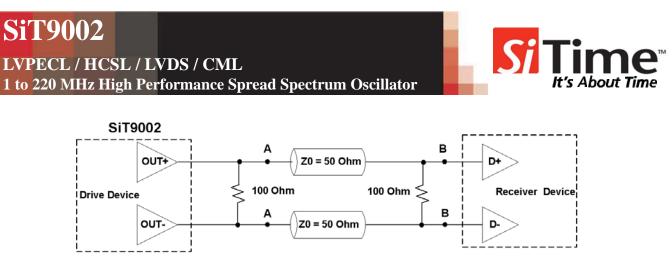
OUT+

OUT

1. All the tests are done with RS = 20 Ohm (recommended).







Note: For AC coupled operation, include/insert decoupling caps at points A or B



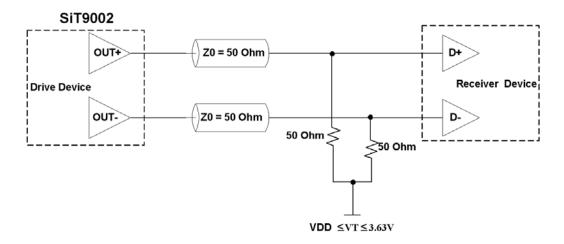


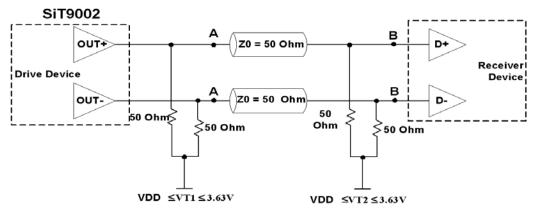
Figure 7. CML Single Load Termination

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# **SiT9002**

# LVPECL / HCSL / LVDS / CML 1 to 220 MHz High Performance Spread Spectrum Oscillator

Si Time



#### Notes:

1. For DC-coupled operation, VT1 = VT2

2. For AC coupled operation, include/insert decoupling caps at points A or B

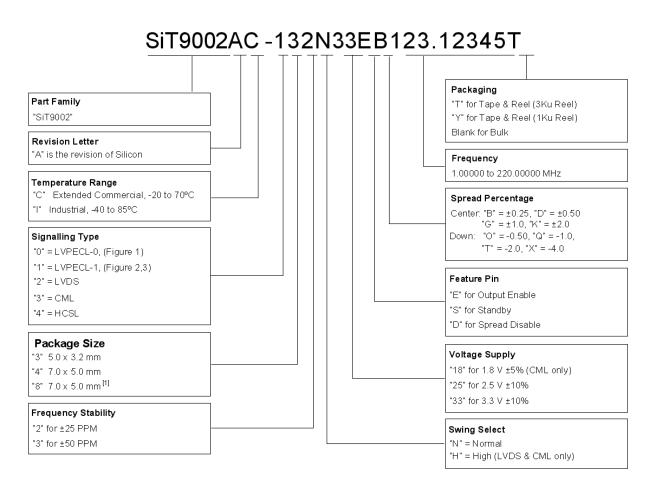
3. For AC-coupled operation with capacitors placed at point A, VT2 sets the input common mode of Receiver Device and need not to be related to VT1

Figure 8. CML Double Load Termination



#### **Ordering Information**

The Part No. Guide is for reference only. For real-time customization and exact part number, use the SiTime Part Number Generator.



# Frequency Stability vs. Temperature Range Options

Frequency	Temperature	Supply Voltage				
Stability (PPM)	Range	1.8 V	2.5 V	3.3 V		
	C (-20 to +70°C)	$\checkmark$	$\checkmark$	$\checkmark$		
±25	I (-40 to +85°C)	$\checkmark$	$\checkmark$	$\checkmark$		
	C (-20 to +70°C)	$\checkmark$	$\checkmark$	$\checkmark$		
±50	I (-40 to +85°C)	$\checkmark$	$\checkmark$	$\checkmark$		

#### Signaling Type vs. Swing Select Options

Signaling		Supply Voltage				
Туре	Swing Select	1.8 V	1.8 V 2.5 V			
	Normal	-	$\checkmark$	$\checkmark$		
LVPECL-0	High	-	-	-		
	Normal	-	$\checkmark$	$\checkmark$		
LVPECL-1	High	-	-	-		
11/20	Normal	-	$\checkmark$	$\checkmark$		
LVDS	High	-	$\checkmark$	$\checkmark$		
0.1	Normal	$\checkmark$	$\checkmark$	$\checkmark$		
CML	High	$\checkmark$	$\checkmark$	$\checkmark$		
	Normal	-	$\checkmark$	$\checkmark$		
HCSL	High	-	-	_		

Note: 1. Without Center Pad.

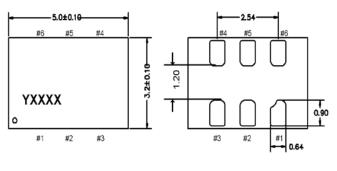


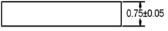
#### Package Information [2]

Dimension (mm)

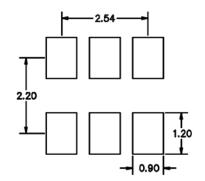
**SiT9002** 

#### 5.0 x 3.2 x 0.75mm

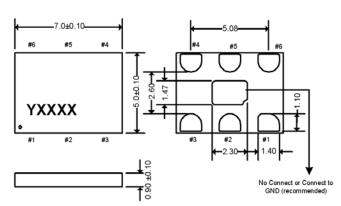


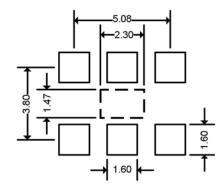


Land Pattern<sup>[3]</sup> (recommended) (mm)



#### 7.0 x 5.0 x 0.90mm





#### Notes:

- 2. Y denotes manufacturing origin and XXXX denotes manufacturing lot number. The value of "Y" will depend on the assembly location of the device.
- 3. A capacitor of value 0.1µF between VDD and GND is recommended.
- 4. The 7050 package with part number designation "-8" has NO center pad.

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